

Kepamid® 2300MR

Polyamide 66

Korea Engineering Plastics Co., Ltd

Message:

KEPAMID 2300MR is unreinforced, mold release nylon66.

Mechanical and thermal property are good.

It is applicable for automobile, electronic and electrical applications.

General Information			
Additive	Mold Release		
Features	Good Mold Release		
Uses	Automotive Applications		
	Electrical Parts		
	Electrical/Electronic Applications		
Forms	Pellets		
Physical	Nominal Value	Unit	Test Method
Density	1.14	g/cm ³	ISO 1183
Hardness	Nominal Value	Unit	Test Method
Rockwell Hardness (R-Scale)	120		ISO 2039-2
Mechanical	Nominal Value	Unit	Test Method
Tensile Stress (Yield)	80.0	MPa	ISO 527-2
Tensile Strain (Break)	30	%	ISO 527-2
Flexural Modulus	2950	MPa	ISO 178
Flexural Stress	115	MPa	ISO 178
Impact	Nominal Value	Unit	Test Method
Charpy Notched Impact Strength	4.0	kJ/m ²	ISO 179
Thermal	Nominal Value	Unit	Test Method
Melting Temperature	260	°C	ISO 11357-3
Flammability	Nominal Value		Test Method
Flame Rating (0.800 mm)	HB		UL 94
Injection	Nominal Value	Unit	
Drying Temperature	80.0	°C	
Drying Time	4.0 to 6.0	hr	
Suggested Max Moisture	< 0.20	%	
Hopper Temperature	260 to 270	°C	
Rear Temperature	260 to 270	°C	
Middle Temperature	265 to 275	°C	
Front Temperature	265 to 275	°C	
Nozzle Temperature	265 to 275	°C	
Mold Temperature	60.0 to 80.0	°C	

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Recommended distributors for this material

Susheng Import & Export Trading Co.,Ltd.

Tel: +86 21 5895 8519

Phone: +86 13424755533

Email: sales@su-jiao.com

No. 215, Lianhe North Road, Fengxian District, Shanghai, China

